

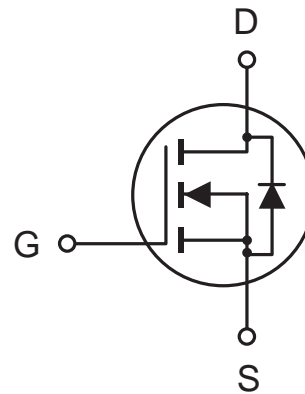
# CED02N6/CEU02N6

Dec. 2002

## N-Channel Logic Level Enhancement Mode Field Effect Transistor

### FEATURES

- 600V , 1.9A ,  $R_{DS(ON)}=5\Omega$  @  $V_{GS}=10V$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handling capability.
- TO-251 & TO-252 package.



6

### ABSOLUTE MAXIMUM RATINGS (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	600	V
Gate-Source Voltage	V <sub>GS</sub>	± 30	V
Drain Current-Continuous (T <sub>c</sub> =25°C)	I <sub>D</sub>	1.9	A
-Continuous (T <sub>c</sub> =100°C)	I <sub>D</sub>	1.2	A
-Pulsed	I <sub>DM</sub>	6	A
Drain-Source Diode Forward Current	I <sub>S</sub>	6	A
Maximum Power Dissipation @T <sub>c</sub> =25°C Derate above 25°C	P <sub>D</sub>	43	W
		0.34	W/°C
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	R <sub>θJC</sub>	2.9	°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub>	50	°C/W

# CED02N6/CEU02N6

## ELECTRICAL CHARACTERISTICS (Tc=25°C unless otherwise noted)

6

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>DRAIN-SOURCE AVALANCHE RATING<sup>a</sup></b>						
Single Pulse Drain-Source Avalanche Energy	E <sub>AS</sub>	V <sub>DD</sub> =50V, L=60mH R <sub>G</sub> =9.1Ω		125		mJ
Maximum Drain-Source Avalanche Current	I <sub>AS</sub>			2		A
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	600			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0V			25	μA
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ±30V, V <sub>DS</sub> = 0V			±100	nA
<b>ON CHARACTERISTICS<sup>a</sup></b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	2		4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> = 1A		3.8	5.0	Ω
On-State Drain Current	I <sub>D(ON)</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 10V	2			A
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> = 50V, I <sub>D</sub> = 1A		1.2		S
<b>SWITCHING CHARACTERISTICS<sup>b</sup></b>						
Turn-On Delay Time	t <sub>D(ON)</sub>	V <sub>DD</sub> = 300V, I <sub>D</sub> = 2A, V <sub>GS</sub> = 10V R <sub>GEN</sub> =18Ω		18	35	ns
Rise Time	t <sub>r</sub>			18	35	ns
Turn-Off Delay Time	t <sub>D(OFF)</sub>			50	90	ns
Fall Time	t <sub>f</sub>			16	40	ns
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = 480V, I <sub>D</sub> = 2A, V <sub>GS</sub> = 10V		20	25	nC
Gate-Source Charge	Q <sub>gs</sub>			2		nC
Gate-Drain Charge	Q <sub>gd</sub>			12		nC

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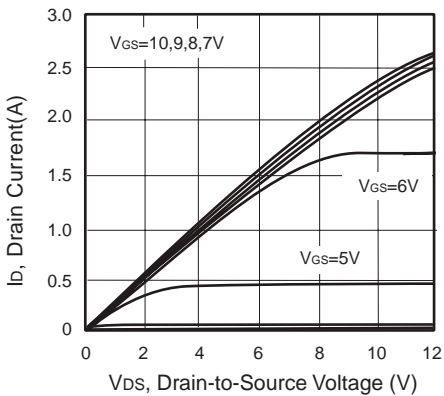
## ELECTRICAL CHARACTERISTICS ( $T_c=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>DYNAMIC CHARACTERISTICS<sup>b</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS}=25\text{V}, V_{GS}=0\text{V}$ $f=1.0\text{MHz}$		250		pF
Output Capacitance	$C_{oss}$			50		pF
Reverse Transfer Capacitance	$C_{rss}$			30		pF
<b>DRAIN-SOURCE DIODE CHARACTERISTICS<sup>a</sup></b>						
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0\text{V}, I_S=2\text{A}$			1.5	V

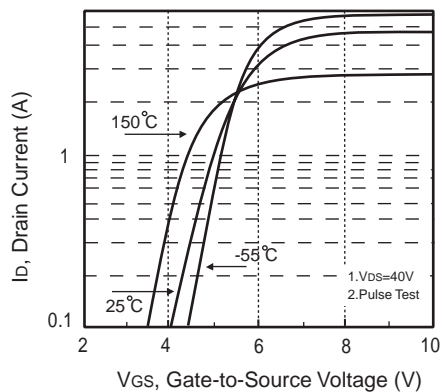
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**Notes**

- a. Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
- b. Guaranteed by design, not subject to production testing.



**Figure 1. Output Characteristics**



**Figure 2. Transfer Characteristics**

# CED02N6/CEU02N6

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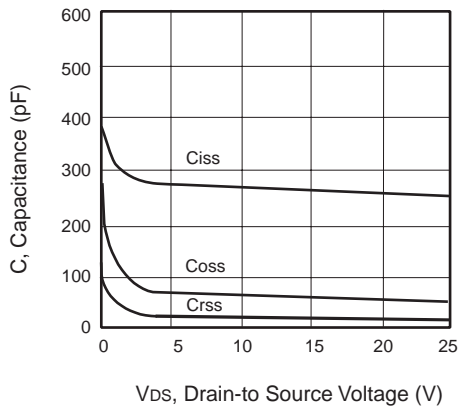


Figure 3. Capacitance

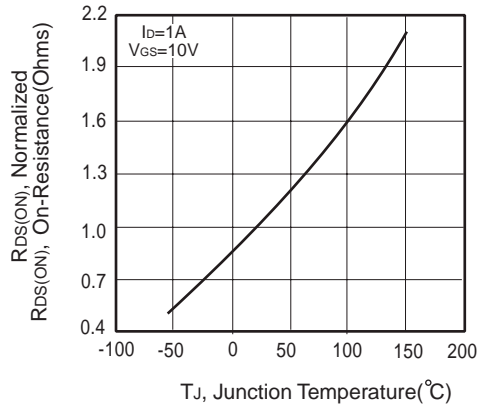


Figure 4. On-Resistance Variation with Temperature

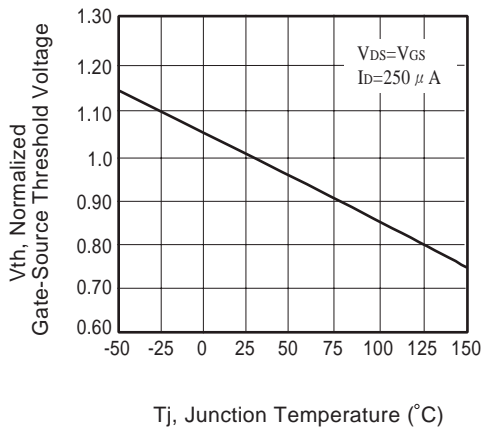


Figure 5. Gate Threshold Variation with Temperature

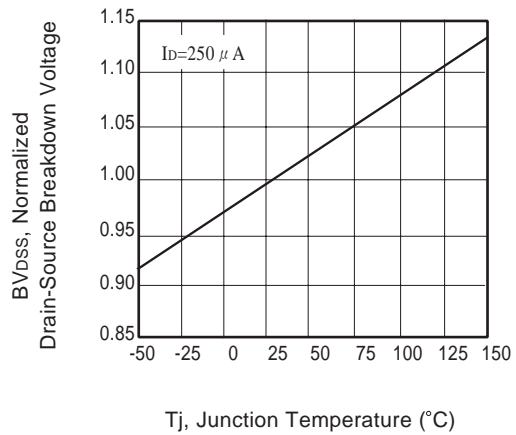


Figure 6. Breakdown Voltage Variation with Temperature

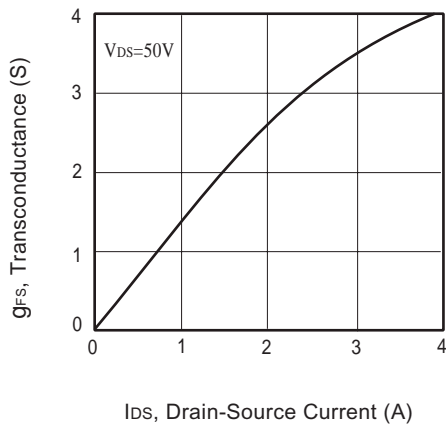


Figure 7. Transconductance Variation with Drain Current

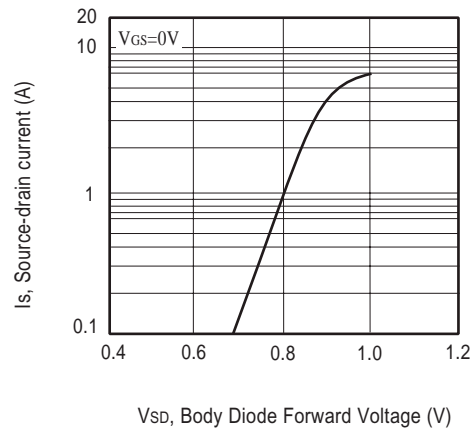


Figure 8. Body Diode Forward Voltage Variation with Source Current

# CED02N6/CEU02N6

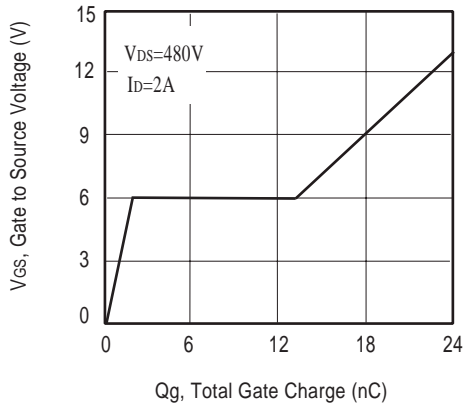


Figure 9. Gate Charge

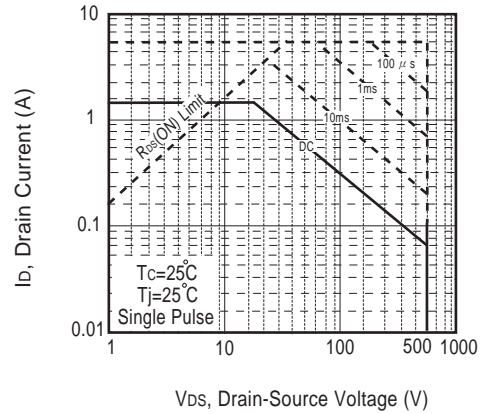


Figure 10. Maximum Safe Operating Area

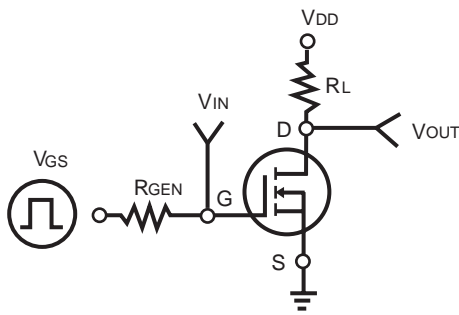


Figure 11. Switching Test Circuit

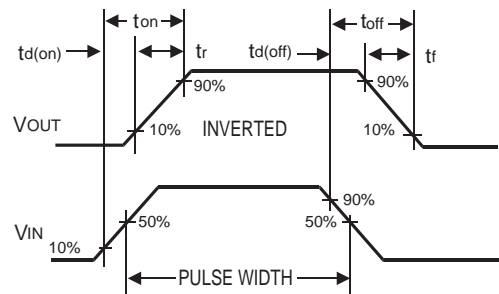


Figure 12. Switching Waveforms

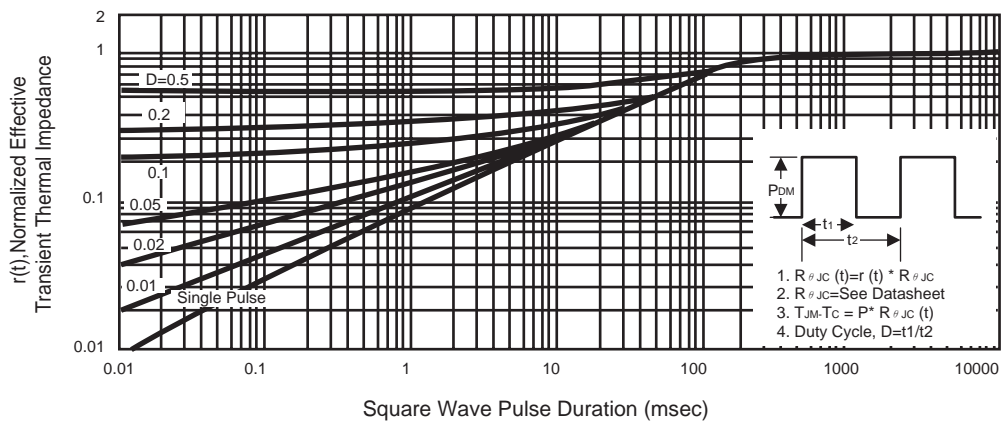


Figure 13. Normalized Thermal Transient Impedance Curve